

MATERIAL DATA SHEET

Material #	SOD-523 series	
Product Line		
Date	2011/10/5	
Rev. date	C	

No.	Construction element	Material group	Material weight (mg)	Material	CAS if applicable	Average mass (%)	Sum(%)	Traces
1	Lead Frame	SDI(A42)	0.386	Nickel	7440-02-0	41.00%	31.13	
				Manganese	7439-96-5	0.70%		
				Cobalt	7740-48-4	0.40%		
				Silicon	7440-21-3	0.20%		
				Chromium	7440-47-3	0.05%		
				Copper	7440-50-8	0.05%		
				Carbon	7740-44-0	0.01%		
				Iron	7439-89-6	56.59%		
				Silver	7740-22-4	1.00%		
2	Wire	Heraeus(GOLD)	0.009	Aurum	7440-57-5	100.00%	0.73	
3	Mold Compound	HuaWei	0.789	Silica Fused	60676-86-0	80.00%	63.63	
				Epoxy resin	29690-82-2	10.00%		
				Phenolic Resin	9003-35-4	7.50%		
				Brominated epoxy resin	40039-93-8	2.00%		
				Carbon Black	1333-86-4	0.50%		
4	Wafer	YanDong	0.03	Silicon	7440-21-3	95.50%	2.34	
				Gold	7440-57-5	3.50%		
				Aluminum	7429-90-5	1.00%		
4	Plating	SinYang(SN)	0.027	Tin	7440-31-5	100.00%	2.18	
		Total weight	1.24					